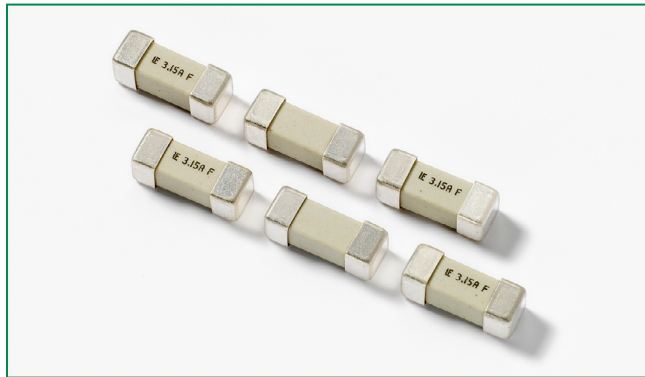


485 Series Fuse



Agency Approvals

Agency	Agency File Number	Ampere Rating
	E10480	1A - 3.15A
	29862	1A - 3.15A

Electrical Characteristics for Series

% of Ampere Rating	Opening Time at 25°C
100%	4 hours, Minimum
200%	60 seconds, Maximum

Description

The 485 Nano²® Fuse Series is a small, fast-acting, surface mount ceramic fuse rated at a remarkable 600VDC at its small size and with 100A breaking capacity. It is primarily designed for circuit protection in high energy applications. This product is fully compatible with lead-free solder alloys and higher temperature profiles associated with lead-free assembly.

Features

- Fast-Acting / Surface mount high voltage (up to 600VDC) applications.
- Fully compatible with lead-free solder alloys and higher temperature profiles associated with lead-free assembly.
- Relatively high breaking capacity at 100A.
- RoHS compliant / Halogen Free
- Rating – 1 - 3.15 Amperes.

Applications

- PC server and Telecom systems
- LCD TV inverter boards DC input protection
- Uninterruptible Power Supply (UPS) / 3-Phase Power Supplies
- 380VDC server / lighting in data center

Additional Information



Datasheet



Resources



Samples

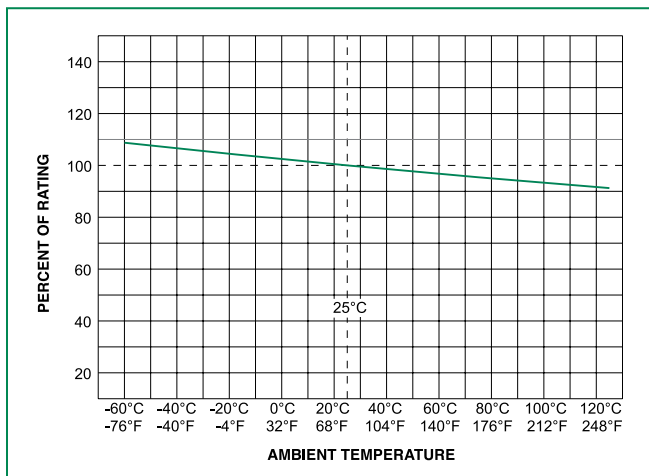
Electrical Specifications by Item

Ampere Rating (A)	Amp Code	Max Voltage Rating (V)	Interrupting Rating	Nominal Cold Resistance (Ohms)	Nominal Melting I ² t (A ² sec)	Agency Approvals	
1.00	001.	600	100A@600VDC, 100A@250VAC	0.264	0.3044	X	X
1.50	01.5	600		0.123	0.3917	X	X
2.00	002.	600		0.0744	0.8962	X	X
2.50	02.5	600		0.0583	1.4921	X	X
3.15	3.15	600		0.0395	3.304	X	X

Notes:

1. Cold resistance measured at less than 10% of rated current at 23°C.
2. Agency Approval Table Key: X=Approved or Certified, P=Pending and Blank=Not Approved.
3. I²t values stated for 8 msec opening time.

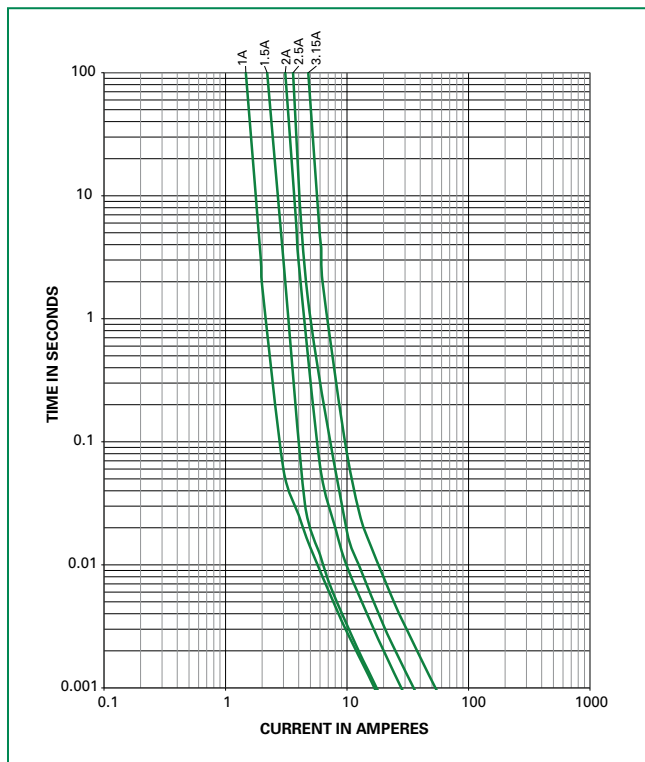
Temperature Re-rating Curve



Note:

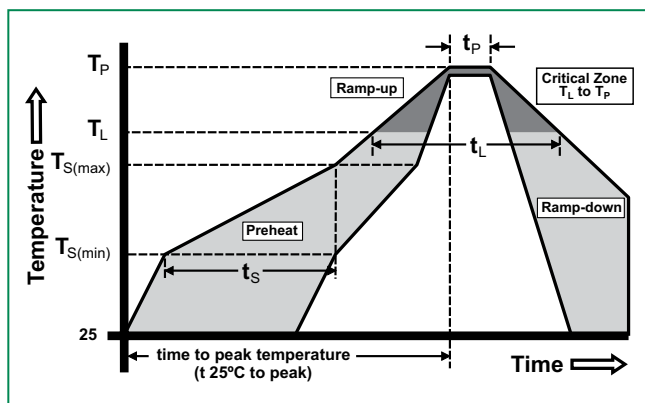
1. Rerating depicted in this curve is in addition to the standard derating of 25% for continuous operation.

Average Time Current Curves



Soldering Parameters - Reflow Soldering

Reflow Condition		Pb – Free Assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (Min to Max) (t_s)	60 – 180 ses
Average Ramp-up Rate (Liquidus Temp (T_L) to peak)		5°C/second max.
$T_{s(max)}$ to T_L - Ramp-up Rate		5°C/second max.
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		5°C/second max.
Time 25°C to peak Temperature (T_p)		8 minutes max.
Do not exceed		260°C



Surface Mount Fuses

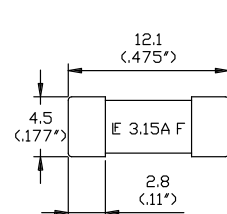
Nano²® > 600VDC > Fast-Acting Fuse > 485 Series

Product Characteristics

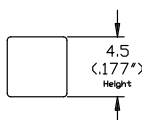
Material	Body: Ceramic Cap: Silver Plated Brass
Product Marking	Body: Brand Logo, Current Rating
Operating Temperature	-55°C to 125°C with proper derating
Moisture Sensitivity Level	Level 1 J-STD-020
Solderability	MIL-STD-202, Method 208
Insulation Resistance (after Opening)	MIL-STD-202, Method 302, Test Condition A (10,000 ohms, Minimum)

Thermal Shock	MIL-STD-202, Method 107, Test Condition B, 5 cycles, -65°C to 125°C, 15 minutes @ each extreme
Mechanical Shock	MIL-STD-202, Method 213, Test Condition I: Deenergized. 100G's peak amplitude, sawtooth wave 6ms duration, 3 cycles XYZ+xyz = 18 shocks
Vibration	MIL-STD-202, Method 201: 0.03" amplitude, 10-55 Hz in 1 min. 2 hrs. each XYZ=6hrs
Moisture Resistance	MIL-STD-202, Method 106, 10 cycles
Salt Spray	MIL-STD-202, Method 101, Test Condition B (48hrs)
Resistance to Soldering Heat	MIL-STD-202, Method 210, Test Condition B (10 sec at 260°C)

Dimensions

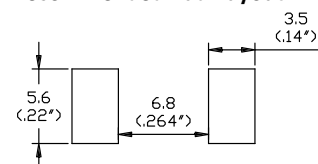


TOP VIEW



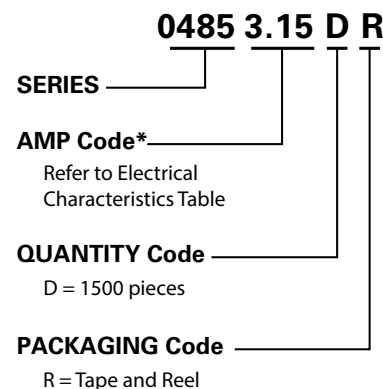
END CAP

Recommended Pad Layout



REFLOW SOLDER

Part Numbering System



***Example**
3.15 amp is 04853.15DR

Packaging

Packaging Option	Packaging Specification	Quantity	Quantity & Option Code
24mm Tape and Reel	EIA-RS 481-1, (IEC 286, Part 3)	1500	DR